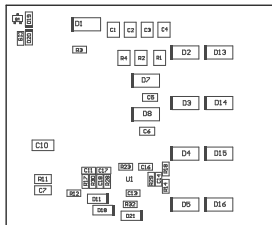


PMP10195 Rev_E Board has been
built on PMP10195 Rev_A PWB

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10195	REV: A	SUN REV: Not In VersionControl
M2 Board Dimensions	M1 Board Outline	TID #: .TID	
PLOT NAME = New PrintOut 1 GENERATED : 01.12.2015 13:26:27	TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10195	REV: A	SUN REV: Not In VersionControl
	TID #: .TID	enituo b7608 IM	
PLOT NAME = New PrintOut 1 GENERATED : 01.12.2015 13:26:27	TEXAS INSTRUMENTS		

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